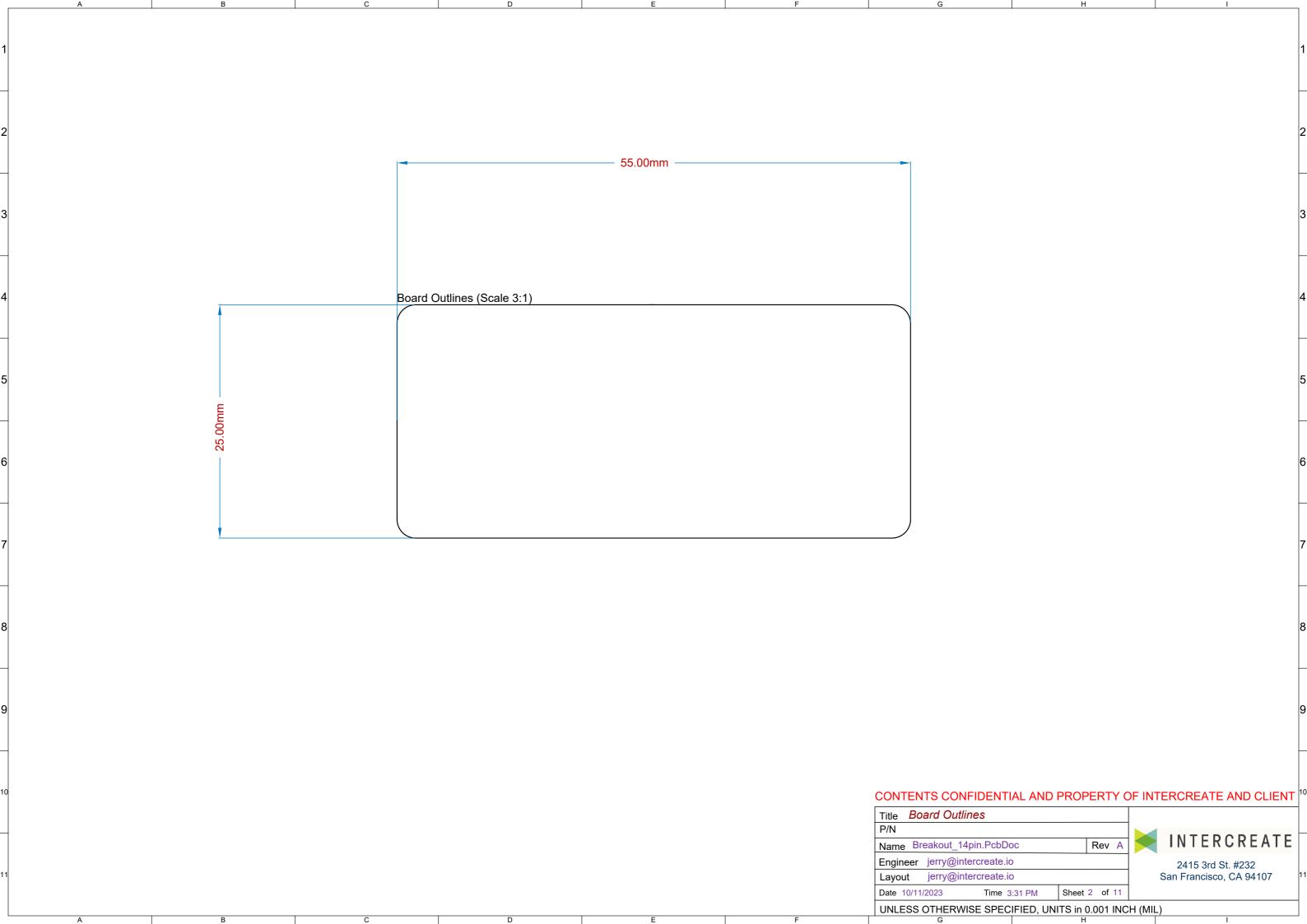
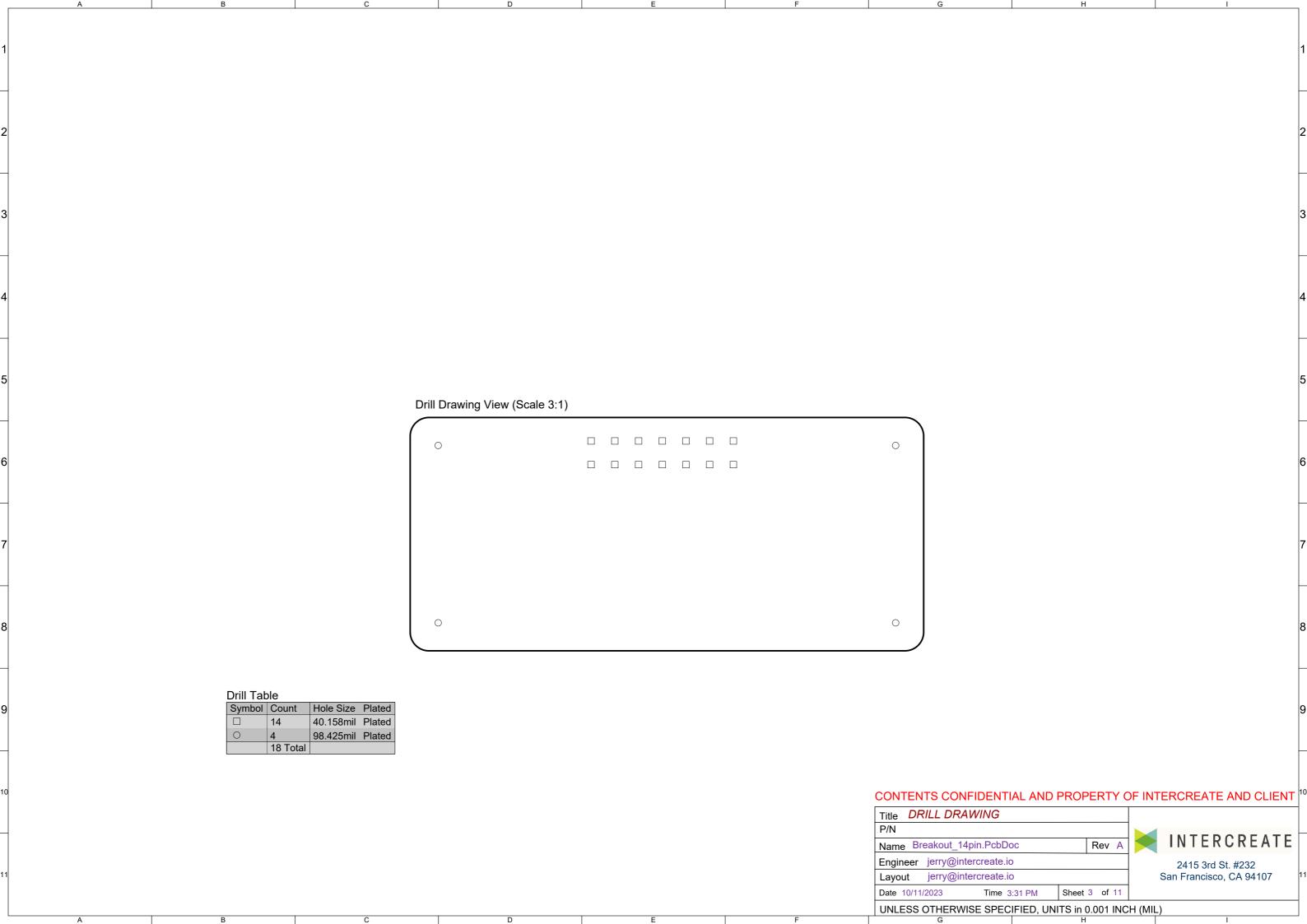
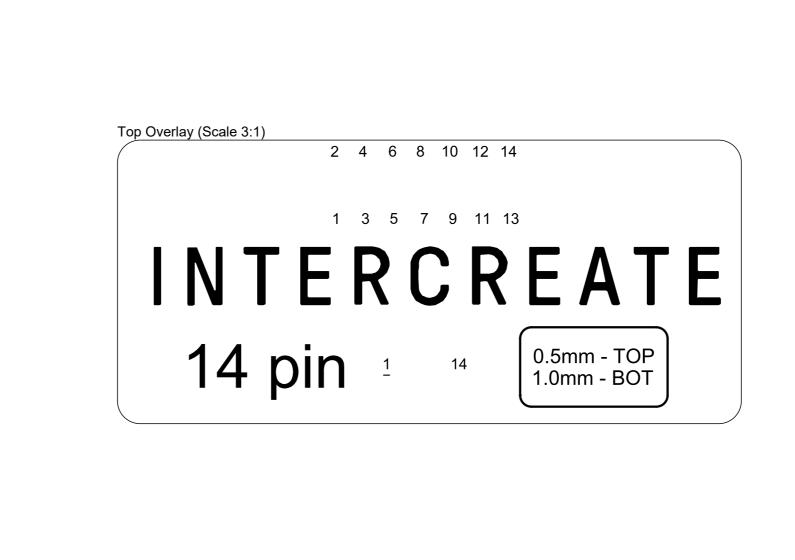
TES (Unless otherwise specified)									
PCB MATERIAL	FR4 or similar								
SOLDER	ENIG per IPC-4552								
WASHABLE	YES								
COPPER WEIGHT FOR OUTER LAYERS	1oz								
				Top Overlay	0.010mm 0.036mm	Solder Resist	Legend Solder Mask Signal	GTO	3.5
			Copper Surface Mate		0.036mm 0.010mm		Signal Solder Mask		4.8 3.5
			Tatal thickney		/		Legend	GBO	
			lotal thicknes	3S: 1.591mm					
			0	TENTO CONFID	A.N.			AND (≏! IENI
			_				FINTERUREA	TE AND C	CLIEN
					DRAWING				
					PcbDoc	Rev A	INTE	RCRE	ATE
			E	Engineer jerry@intercr	eate.io		2415 3rd	rd St. #232	2
			L	Layout jerry@intercr	eate.io		San Francis	sco, CA 94	107
				Date 10/11/2023	Time 3:31 PM	Sheet 1 of 11			
	PCB MATERIAL SOLDER WASHABLE	PCB MATERIAL SOLDER ENIG per IPC-4552 WASHABLE COPPER WEIGHT FOR OUTER LAYERS PCB PLATING PCB PLATING ENIG per IPC-4552 VIA SIZE VIA SIZE VIA IN PAD VIA FILL NO VIA TENTING BOTH SIDES SOLDER MASK COLOR SILK SCREEN COLOR ACCEPTANCE FR4 or similar FR4 o	PCB MATERIAL SOLDER ENIG per IPC-4552 WASHABLE YES COPPER WEIGHT FOR OUTER LAYERS 10z PCB PLATING ENIG per IPC-4552 VIA SIZE See Drill Table VIA IN PAD NO VIA FILL NO VIA TENTING BOTH SIDES SOLDER MASK COLOR GRAY SILK SCREEN COLOR HITE ACCEPTANCE IPC-4-600 Class II PCB FINISH Layer Stack Legend	PCB MATERIAL SOLDER ENIG per IPC-4552 WASHABLE YES COPPER WEIGHT FOR OUTER LAYERS 102 POS PLATING ENIC per IPC-4552 VIA SIZE See Drill Table VIA IN PAD NO VIA FILL NO SILK SCREEN COLOR GRAY SILK SCREEN COLOR HHTE ACCEPTANCE IPC-4552 Layer Stack Legend Material Surface Mate Copper Total thickness Total thickness	PCB MATERIAL SOLDER ENIG per IPC-4552 WASHABLE VES COPPER WEIGHT FOR OUTER LAYERS 10z PCB PLATING ENIO per IPC-4552 VIA SIZE Sao PIII Table WAIN PAD NO VIA TENTING BOTH SIDES SOLDER MASK COLOR GRAY SILK SCREED COLOR WHITE ACCEPTANCE IPC-4502 Layor Stack Logend Material Layer Top Overlay Surface Material Top Solder Top Layer Surface Material Top Solder Top Layer Top Overlay Top Inchess: 1.59 Imm CONTENTS CONFID	PCB MATERIAL SOLDER ENIG per IPC-4552 WASHABLE YES COPPER WEIGHT FOR OUTER LAYERS 102 PCB PLATING ENIG per IPC-4552 VIA SIZE See Drill Table VIA IN FAD NO VIA FILL NO WIA TENTING BOTH SIDES SOLDER MASK COLOR GRAY SILK SCREEN COLOR FPC-A-600 Class III PCB FINISH POB FINISH PCB FINISH Layer Stack Legend Material Layer Thickness Top Overlay Surface Material Bottom Solder Outform Bottom Overlay Total thickness: 1.591mm CONTENTS CONFIDENTIAL AN Title FABRICATION DRAWING PN Name Breadout 1-fain PubDic Finishor Marginetic Plane PubDic Finishor Margineters Also.	PCB MATERIAL SOLDER ENIO per IPC-4552 WASHABLE YES COPPER WEIGHT FOR OUTER LAYERS 102 VIA SUZE See Drill Table VIA IN PAD NO VIA FILL NO SOLDER MASK CLOR GRAY SILK SCREEN COLOR WHITE ACCEPTANCE IPC-4552 Layer Stack Legend Material Layer Top Dverlay Surface Material Top Socier O.000mm FR-4 Copper Bottom Layer Total thickness: 1.591mm CONTENTS CONFIDENTIAL AND PROPERTY OI Time: FABRICATION DRAWING FN Name Revised, Liquin Peditor. Rev A Eppmage File Policy Componers Policy Contents Revised Contents Revised Contents Con	PCB MATERIAL SOLDER ENIOper IPC-4592 WASHABLE YES COPPER WEIGHT FOR DUTER LAYERS 102 PCB PLATINC PCB PLATINC PCB PLATINC PCB PLATINC VIA NEAD NO VIA FILL NO VIA FILL NO VIA FILL NO SOLDER MASK COLOR GRAY SILK SCREEN COLOR WHITE ACCEPTANCE PCB FINISH PC-4502 Layer Stack Legend Material Layer Tinickness Dielectric Material Type Top Orellary Outforce Material Top Solder Copper Top Layer Outforce Top Orellary Outforce Outforce Top Chrolisty Outforce Outforce Top Orellary Top Orellary Outforce Top Orellary Top Orellary Outforce Top Orellary Top Orellary Top Orellary Top Orellary Top Orellary Top Outforce Top Orellary To	PCB MATERIAL SOLDER SOLDER SOLDER SOLDER SEND per IPC-4582 VISSIE COPPER WEICHT FOR DUTER LAYERS 102 PCB PLATING BKID per IPC-4582 VIA SIZE SED BIT Table VIA IN PAD NO VIA PILL NO VIA PILL NO SOLDER MASK COLOR GRAY SILK SCREEN COLOR PCB INVSH PCB INVSH PCB INVSH SOLDER MASK COLOR GRAY SILK SCREEN COLOR PCB INVSH PCB INVSH PC 4582 Layer Stack Logend Material Layer Théctoress Delectric Material Type Gerber Copper 1 po Joventry Control Solder Resist Solder Resist Solder Mask Signal GIT Told Placement Layer Théctoress Delectric Material Type Gerber Signal GIT Told Placement Layer Solder Resist Solder Mask CBS Told Placement Layer Théctoress Delectric Material Type Gerber Signal GIT Told Placement Layer Théctoress Delectric Material Type Gerber Signal GIT Told Placement Layer Théctoress Delectric Material Type Gerber Signal GIT The FABRICA TION DRAWING Told Placement Layer Théctoress Delectric Material Type Gerber Signal GIT The FABRICA TION DRAWING Name Girchard, Samp Pebbor Na

UNLESS OTHERWISE SPECIFIED, UNITS in 0.001 INCH (MIL)







TOP LAYER SILKSCREEN INTERCREATE Name Breakout_14pin.PcbDoc Rev A Engineer jerry@intercreate.io 2415 3rd St. #232 San Francisco, CA 94107

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